

From: Saldana, Evette <esaldana@lehman.com>
Sent: Friday, June 15, 2007 7:05 PM (GMT)
To: HYCC Members-US <HYCCMembers-US@EXAMNYC.lehman.com>; Bridge Loan Committee <bridge_loan_committee@EXAMNYC.lehman.com>; HGCC US Loans <hgccusloans@lehman.com>
Subject: *PRESENTATION* 2007 High Grade and High Yield Credit Facilitation Summary Meeting: Tuesday, June 19th @ 3:00pm ET
Attach: HGHY Loan Facilitation_2Q07_Final.ppt

<<HGHY Loan Facilitation_2Q07_Final.ppt>>

> - 2007 High Grade and High Yield Credit Facilitation Summary
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> Presenter: Ray Kahn